07/14/03

UTILITY PATENT APPLICATION TRANSMITTAL

(New Nonprovisional Applications Under 37 CFR § 1.53(b))

Attorney Docket No. 20003-7004

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is the patent application of () application identifier or (X) first named inventor, Phillip G. Wessells, entitled Flexible Device Mounting System and Method, for a(n):

entitled <u>Flexible Device</u>	iviounting System and ivi	einoa, for a(n):				
(X) Original Patent Ap	pplication.					
() Continuing Application (prior application not abandoned): () Continuation () Divisional () Continuation-in-part (CIP) of prior application No: Filed on: () A statement claiming priority under 35 USC § 120 has been added to the specification.						S. PTO
of prior application No:Filed on:						
CLAIMS AS FILED						
FOR	NO. FILED	NO. EX		RATE	FEE	
Total Claims	39	19	1	\$9.00		171.00
Independent Claims	4	1		\$42.00		\$ 42.00
Multiple Dependent Claims (if applicable) \$0.00						
Assignment Recording Fee \$0.00						
Basic Filing Fee						375.00
				Total Filing F	ee \$	588.00
Charge \$ to Deposit Account pursuant to 37 CFR § 1.25. At any time during the pendency of this application, please charge any fees required or credit any overpayment to this Deposit Account. Respectfully submitted						
Date: 14 July 2003 Correspondence Address:			Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450			
Patent Law Offices of Michael E. Woods 89 Corte Cayuga Greenbrae, CA 94904			Typed Name: Michael E. Woods			

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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		Wessells, et al.				
Title	Flexible Device Mounting System and Method					
Atty Docket Number		20003-7004				

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

14 Jaly 2003 Date

Signature

Michael E. Woods
Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.